#### SCOPE:

This specification applies to the Pb Free high current type SMD inductors for

MSI-900609V-SERIES-\_-

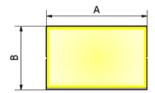
Warn: This product series can't be used in synchronous rectification circuit that is over 24V.

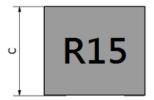
#### PRODUCT INDENTIFICATION

MSI - 900609V - R15 K - E -□□

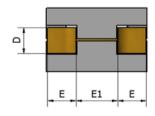
- (I)
- 0
- 3 4
- (5)
- 1 Product Code
- **2 Dimensions Code**
- **3 Inductance Code**
- **4** Tolerance Code
- **⑤ Inner Control Code**

## (1) SHAPES AND DIMENSIONS(mm)











A: 9.60 Max. mm
B: 6.40 Max. mm
C: 9.0 Max. mm
D: 2.6 Typ. mm
E: 2.5 Typ. mm
E1: 4.0 Typ. mm

Note: Standard of the printing area, parts of the surface are the qualified Marking non-directional printing limit

# (2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

**TEST INSTRUMENTS** 

L: HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

Isat: WK3255B+3265B (or equivalent)



#### **TABLE 1**

MAGLAYERS	Inductance	Percent	Resistance	Rated DC Current			Marking
PT/NO.	L(µH)	Tolerance	RDC(mΩ)	Isat1(A)	Isat2(A)	Irms(A)	Marking
MSI-900609V-R12∐-E	0.12	K,L,M	0.17±5%	94.0	75.0	66.0	R12
MSI-900609V-R15∐-E	0.15	K,L,M	0.17±5%	75.0	55.0	66.0	R15
MSI-900609V-R30⊡-E	0.30	K,L,M	0.17±5%	33.0	29.0	66.0	R30

Test Frequency: 100kHz/1.0V

**※** ☐ specify the inductance tolerance,K(±10%),L(±15%),M(±20%)

**%Isat1**: Based on inductance change (△L/Lo: drop 20% Typ.)@ ambient temp. 25°C

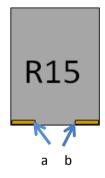
Isat2: Based on inductance change (△L/Lo: drop 20% Typ.)@ ambient temp. 125℃

Irms: Based on temperature rise (△T: 40°C TYP.)

Rated DC Current: The less value which is Isat1 or Irms.

#### **RDC TEST POINT**

The nominal DCR is measured from point "a" to point "b".





# (4) RELIABILITY TEST METHOD

## ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^\circ\!\mathrm{C}$ ,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20℃≦±10%.

#### **MECHANICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS		
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
		in figure 1 and a load applied unitil the figure in the arrow		
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)		
	no mechanical	PCB dimension shall the page 7/9		
	damage or elec-	F(Pressurization)		
	trical damage.	$\Box$		
		R5 45±2 45±2		
		10 20 R340		
		PRESSURE ROD figure-1		

#### **MECHANICAL**

TEST ITEM	SPECIFICATION					
Vibration	∆L/Lo≦±5%	L/Lo≦±5% The sample shall be soldered onto the printed circuit board				
		and when a vibration having an amplitude of 1.52mm				
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should				
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.				
	damage.	(A total of 6 hours)				
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated				
• • • • • • • • • • • • • • • • • • •	More than 90%	over the whole of the sample before hard, the sample shall				
		then be preheated for about 2 minutes in a temperature of				
		130~150°C and after it has been immersed to a depth 0.5mm below for 3±0.2 seconds fully in molten solder M705 with a temperature of 245±5°C.  More than 90% of the electrode sections shall be couered				
		with new solder smoothly when the sample is taken out of				
		the solder bath.				
Resistance to	There shall be	Temperature profile of reflow soldering				
Soldering heat	no damage or	soldering				
(reflow soldering)	problems.	© 300 — (Peak temperature 260±3°C 10 sec)				
		(Peak temperature 260±3°C 10 sec)  Pre-heating  Soldering (Peak temperature 260±3°C 10 sec)  30 sec Min (230+0°C)  Slow cooling (Stored at rottemperature)				
		200 30 sec Min				
		E				
		50 150 Slow cooling				
		⊕ 100 _ / 150 ~ 180°C (Stored at room				
		50 temperature)				
		-				
		10				
		2 min sec. 2 min. or more				
		The specimen shall be passed through the reflow oven with the				
		condition shown in the above profile for 1 time.				
		The specimen shall be stored at standard atmospheric conditions				
		for 1 hour, after which the measurement shall be made.				
		,				



## **ENVIROMENT CHARACTERISTICS**

TEST ITEM				SPECIFICATION			
High temperature	∆L/Lo≦±5%	The san	The sample shall be left for 96±4 hours in an atmospere with				
storage		a tempe	a temperature of 125 $^{\circ}$ C and a normal humidity.				
	There shall be	Upon completion of the measurement shall be made after the				the	
	no mechanical	sample has been left in a normal temperature and normal humidity for 1 hour.					
	damage.						
Low temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmosphere with					
storage		a temperature of -40±3℃.					
	There shall be	Upon co	Upon completion of the test, the measurement shall be made				
	no mechanical	after the	after the sample has been left in a normal temperature and				
	damage.	normal	normal humidity for 1 hour.				
Change of	∆L/Lo≦±5%	The san	The sample shall be subject to 5 continuos cycles, such as shown				
emperature		in the ta	in the table 2 below and then it shall be subjected to standard				
	There shall be	atmospheric conditions for 1 hour, after which measurement					
	no other dama-	shall be	shall be made.				
	ge of problems						
		table 2					
				Temperature	Duration		
			1	-40±3℃	30 min.		
			•	(Themostat No.1)			
			2	Standard	No.1→No.2		
				atmospheric	NO.1→NO.2		
			3	125±2℃	30 min.		
			(Themostat No.2)	(Themostat No.2)	30 mm.		
			4	Standard	No.2→No.1		
			•	atmospheric			
Moisture storage	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in a temperature of					
Moisture storage			40±2°C and a humidity(RH) of 90∼95%.				
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	after the sample has been left in a normal temperature and					
	damage.	normal humidity more than 1 hour.					
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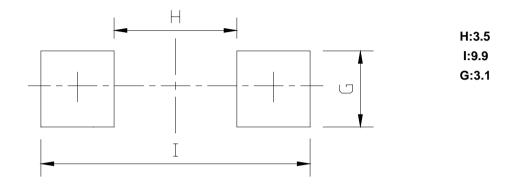


# (5) LAND DIMENSION (Ref.)

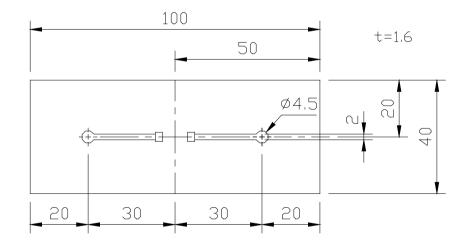
PCB: GLASS EPOXY t=1.6mm

#### (5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) Unit:(mm)

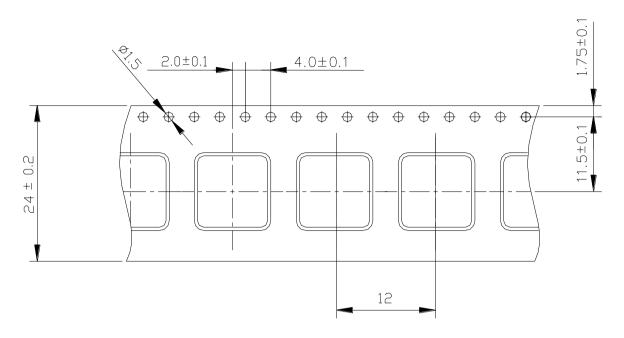


## (5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD

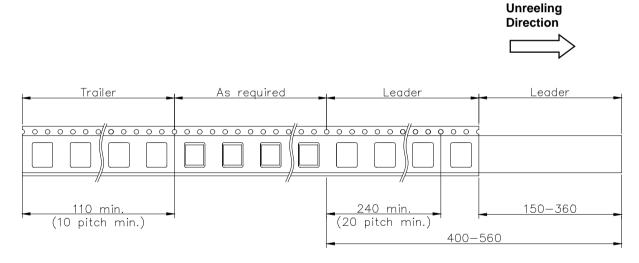


## (6) PACKAGING

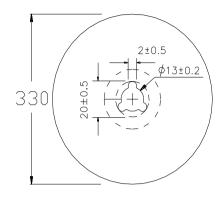
## (6)-1 CARRIER TAPE DIMENSIONS (mm)

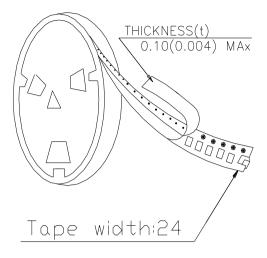


## (6)-2 TAPING DIMENSIONS (mm)



## (6)-3 REEL DIMENSIONS (mm)





## (6)-4 QUANTITY

500 pcs/Reel

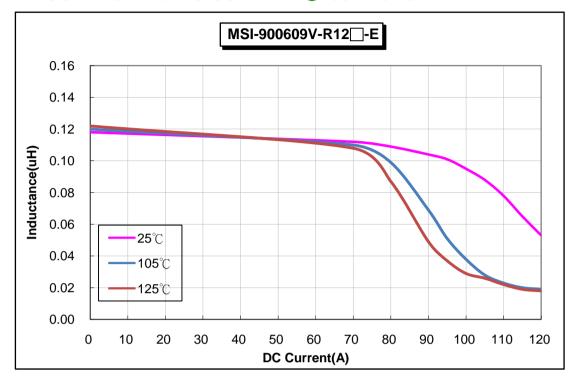
The products are packaged so that no damage will be sustained.

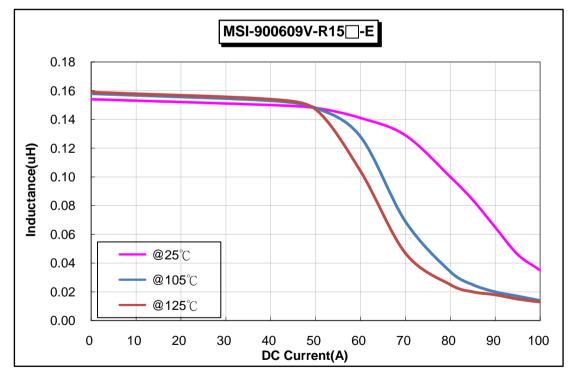
Please note that the contents may change without any prior notice due to reasons such as upgrading.



#### TYPICAL ELECTRICAL CHARACTERISTICS

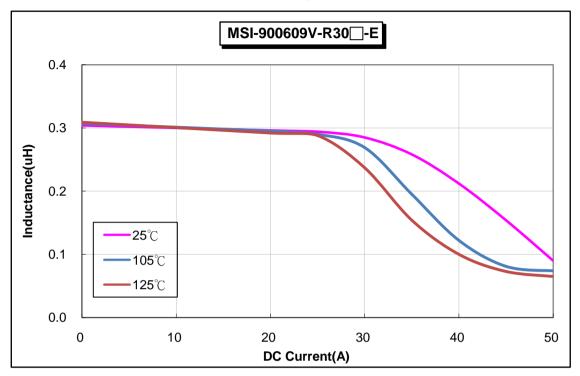
#### INDUCTANCE vs. DC CURRENT@100kHz/1.0V





## TYPICAL ELECTRICAL CHARACTERISTICS

#### INDUCTANCE vs. DC CURRENT@100kHz/1.0V



## TYPICAL ELECTRICAL CHARACTERISTICS

# **Temperature Rise vs. DC Current**

